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Unit: mm

TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type

SSM6N37CTD

Power Management Switch Applications

• 1.5V drive

Low ON-resistance R_{on} = 5.60 Ω (max) (@V_{GS} = 1.5 V)

 $R_{on} = 4.05 \Omega \text{ (max) (@V_{GS} = 1.8 V)}$

 $R_{on} = 3.02 \Omega \text{ (max) } (@V_{GS} = 2.5 \text{ V})$

 $R_{on} = 2.20 \Omega \text{ (max) } (@V_{GS} = 4.5 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	20	(Y)	
Gate-source voltage		V_{GSS}	± 10	(Vx))	
Drain current	DC	I _D	250	mA	
	Pulse	I _{DP}	500		
Drain power dissipation		P _D (Note 1)	140	→ mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature		T _{stg}	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Weight: 1.0 mg (typ.)

CST6D

JEDEC

JEITA

TOSHIBA

Top View

0.15+0.03

1.Source 1

2.Gate1

3.Drain2

4.Source2

5.Gate2

6.Drain1

2-1S1A

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions", "Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating

Mounted on an FR4 board

Polarity mark

 $(10 \text{ mm} \times 10 \text{ mm} \times 1.0 \text{ mm}, \text{ Cu Pad: } 100 \text{ mm}^2)$

Marking Pin Condition (top view) Equivalent Circuit (top view)

Start of commercial production 2009-12

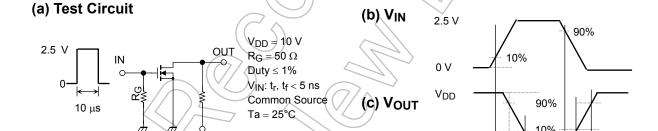
Polarity mark (on the top)
*Electrodes: on the bottom

Electrical Characteristics (Ta = 25°C) (Q1, Q2 Common)

Char	acteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain-source breakdown voltage	V (BR) DSS	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	20	_	_	- V	
	V (BR) DSX	$I_D = 1 \text{ mA}, V_{GS} = -10 \text{ V}$	12	_	_		
Drain cutoff currer	nt	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V	<u></u>	_	1	μА
Gate leakage curr	ent	I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$	7	_	±1	μА
Gate threshold vo	Itage	V _{th}	$V_{DS} = 3 \text{ V}, I_D = 1 \text{ mA}$	0.35) / _	1.0	V
Forward transfer a	admittance	Y _{fs}	$V_{DS} = 3 \text{ V}, I_D = 100 \text{ mA}$ (Note 2)	0.14	0.28	_	S
Drain-source ON-resistance	R _{DS} (ON)	$I_D = 100 \text{ mA}, V_{GS} = 4.5 \text{ V}$ (Note 2)	$\langle \mathcal{L} \rangle$	1.65	2.20	- Ω	
		$I_D = 50 \text{ mA}, V_{GS} = 2.5 \text{ V}$ (Note 2)		2.16	3.02		
		$I_D = 20 \text{ mA}, V_{GS} = 1.8 \text{ V}$ (Note 2)	۲	2.66	4.05		
		$I_D = 10 \text{ mA}, V_{GS} = 1.5 \text{ V}$ (Note 2)	—	3,07	5.60		
Input capacitance		C _{iss}		_ /	12	\\	
Output capacitance		Coss	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-6	5.5	_	pF
Reverse transfer capacitance		C _{rss}		>(4.1	_	
Switching time	Turn-on time	t _{on}	V _{DD} = 10 V, I _D = 100 mA		18/	_	- ns
	Turn-off time	t _{off}	$V_{GS} = 0$ to 2.5 V, $R_G = 50 \Omega$		36	_	
Drain-source forward	ard voltage	V _{DSF}	$I_D = -250 \text{ mA}, V_{GS} = 0 \text{ V}$ (Note 2)		-0.9	-1.2	V

Note 2: Pulse test

Switching Time Test Circuit (Q1, Q2 Common)



Precaution

Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to be low (1mA for the SSM6N37CTD). Then, for normal switching operation, $V_{GS(on)}$ must be higher than V_{th} , and $V_{GS(off)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on)}$.

Take this into consideration when using the device.

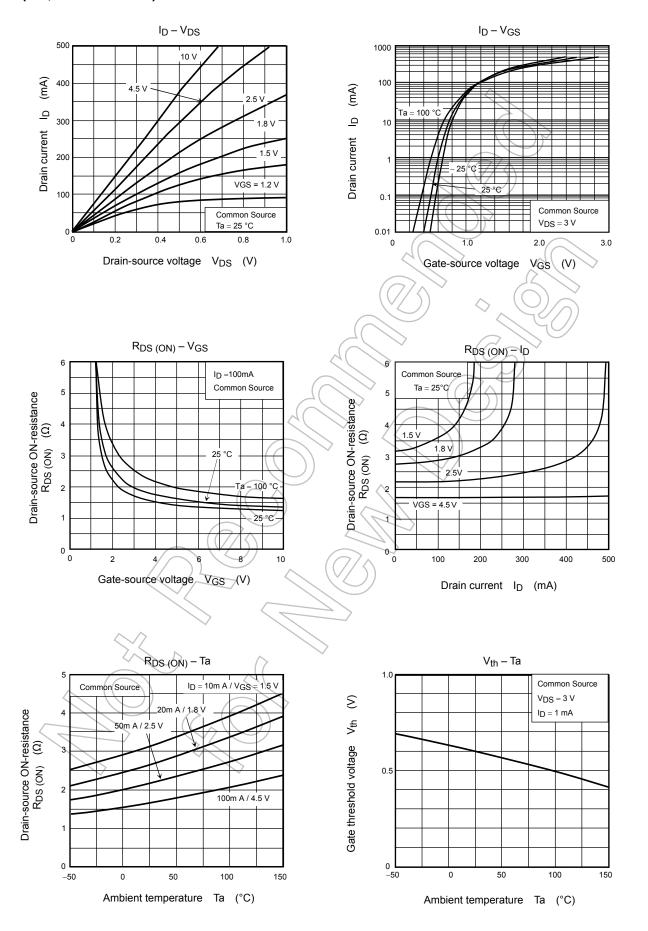
Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

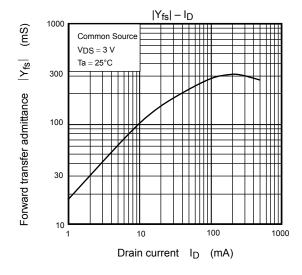
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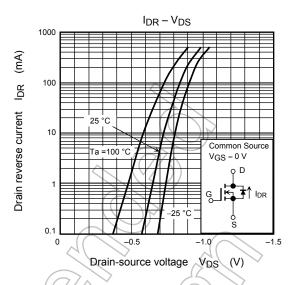
V_{DS} (ON)

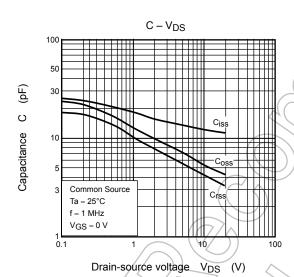
(Q1, Q2 Common)

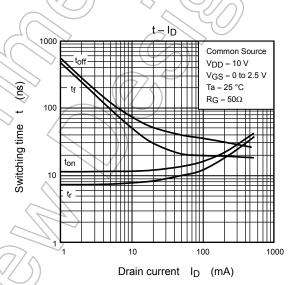


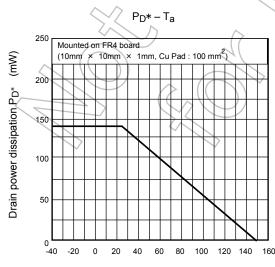
(Q1, Q2 Common)











*:Total Rating Ambient temperature Ta (°C)

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